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Embedded - System On Chip (SoC): The Heart of Modern Embedded Systems

Embedded - System On Chip (SoC) refers to an integrated circuit that consolidates all the essential components of a computer system into a single chip. This includes a microprocessor, memory, and other peripherals, all packed into one compact and efficient package. SoCs are designed to provide a complete computing solution, optimizing both space and power consumption, making them ideal for a wide range of embedded applications.

What are Embedded - System On Chip (SoC)?

System On Chip (SoC) integrates multiple functions of a computer or electronic system onto a single chip. Unlike traditional multi-chip solutions, SoCs combine a central

Details

Product Status	Obsolete
Architecture	MCU, FPGA
Core Processor	Dual ARM® Cortex®-A9 MPCore™ with CoreSight™
Flash Size	-
RAM Size	64KB
Peripherals	DMA, POR, WDT
Connectivity	EBI/EMI, Ethernet, I ² C, MMC/SD/SDIO, SPI, UART/USART, USB OTG
Speed	700MHz
Primary Attributes	FPGA - 350K Logic Elements
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	896-BBGA, FCBGA
Supplier Device Package	896-FBGA, FC (31x31)
Purchase URL	https://www.e-xfl.com/product-detail/intel/5asxmb3e6f31c6n

Feature	Description	
Embedded Hard IP blocks	Variable-precision DSP	<ul style="list-style-type: none"> Native support for up to four signal processing precision levels: <ul style="list-style-type: none"> Three 9 x 9, two 18 x 18, or one 27 x 27 multiplier in the same variable-precision DSP block One 36 x 36 multiplier using two variable-precision DSP blocks (Arria V GZ devices only) 64-bit accumulator and cascade for systolic finite impulse responses (FIRs) Embedded internal coefficient memory Preadder/subtractor for improved efficiency
	Memory controller (Arria V GX, GT, SX, and ST only)	DDR3 and DDR2
	Embedded transceiver I/O	<ul style="list-style-type: none"> Custom implementation: <ul style="list-style-type: none"> Arria V GX and SX devices—up to 6.5536 Gbps Arria V GT and ST devices—up to 10.3125 Gbps Arria V GZ devices—up to 12.5 Gbps PCI Express® (PCIe®) Gen2 (x1, x2, or x4) and Gen1 (x1, x2, x4, or x8) hard IP with multifunction support, endpoint, and root port PCIe Gen3 (x1, x2, x4, or x8) support (Arria V GZ only) Gbps Ethernet (GbE) and XAUI physical coding sublayer (PCS) Common Public Radio Interface (CPRI) PCS Gigabit-capable passive optical network (GPON) PCS 10-Gbps Ethernet (10GbE) PCS (Arria V GZ only) Serial RapidIO® (SRIO) PCS Interlaken PCS (Arria V GZ only)
Clock networks	<ul style="list-style-type: none"> Up to 650 MHz global clock network Global, quadrant, and peripheral clock networks Clock networks that are not used can be powered down to reduce dynamic power 	
Phase-locked loops (PLLs)	<ul style="list-style-type: none"> High-resolution fractional PLLs Precision clock synthesis, clock delay compensation, and zero delay buffering (ZDB) Integer mode and fractional mode LC oscillator ATX transmitter PLLs (Arria V GZ only) 	



Feature	Description
Configuration	<ul style="list-style-type: none">• Tamper protection-comprehensive design protection to protect your valuable IP investments• Enhanced advanced encryption standard (AES) design security features• CvP• Partial and dynamic reconfiguration of the FPGA• Active serial (AS) x1 and x4, passive serial (PS), JTAG, and fast passive parallel (FPP) x8, x16, and x32 (Arria V GZ) configuration options• Remote system upgrade

Arria V Device Variants and Packages

Table 3: Device Variants for the Arria V Device Family

Variant	Description
Arria V GX	FPGA with integrated 6.5536 Gbps transceivers that provides bandwidth, cost, and power levels that are optimized for high-volume data and signal-processing applications
Arria V GT	FPGA with integrated 10.3125 Gbps transceivers that provides enhanced high-speed serial I/O bandwidth for cost-sensitive data and signal processing applications
Arria V GZ	FPGA with integrated 12.5 Gbps transceivers that provides enhanced high-speed serial I/O bandwidth for high-performance and cost-sensitive data and signal processing applications
Arria V SX	SoC with integrated ARM-based HPS and 6.5536 Gbps transceivers
Arria V ST	SoC with integrated ARM-based HPS and 10.3125 Gbps transceivers

Arria V GX

This section provides the available options, maximum resource counts, and package plan for the Arria V GX devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Altera Product Selector.

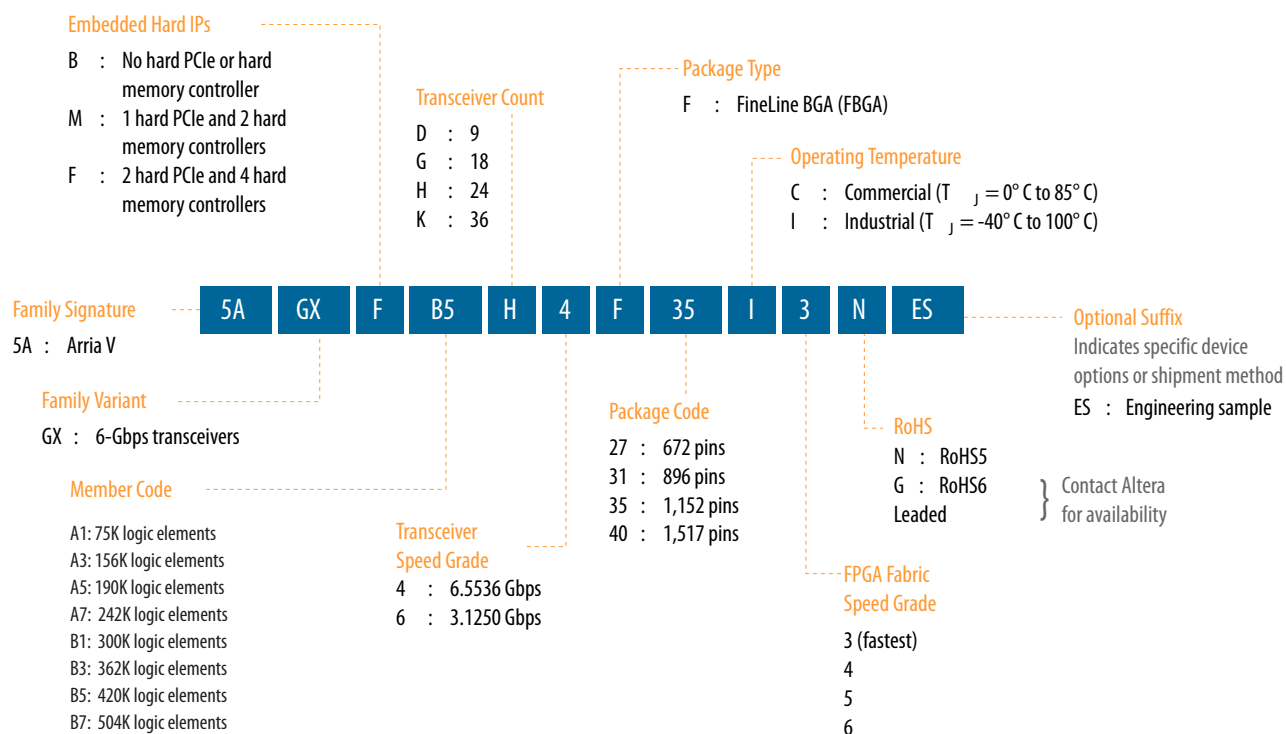
Related Information

[Altera Product Selector](#)

Provides the latest information about Altera products.

Available Options

Figure 1: Sample Ordering Code and Available Options for Arria V GX Devices



Maximum Resources

Table 4: Maximum Resource Counts for Arria V GX Devices

Resource		Member Code							
		A1	A3	A5	A7	B1	B3	B5	B7
Logic Elements (LE) (K)		75	156	190	242	300	362	420	504
ALM		28,302	58,900	71,698	91,680	113,208	136,880	158,491	190,240
Register		113,208	235,600	286,792	366,720	452,832	547,520	633,964	760,960
Mem ory (Kb)	M10K	8,000	10,510	11,800	13,660	15,100	17,260	20,540	24,140
	MLAB	463	961	1,173	1,448	1,852	2,098	2,532	2,906
Variable- precision DSP Block		240	396	600	800	920	1,045	1,092	1,156
18 x 18 Multiplier		480	792	1,200	1,600	1,840	2,090	2,184	2,312
PLL		10	10	12	12	12	12	16	16

Resource		Member Code			
		C3	C7	D3	D7
Transceiver	6 Gbps ⁽⁴⁾	3 (9)	6 (24)	6 (24)	6 (36)
	10 Gbps ⁽⁵⁾	4	12	12	20
GPIO ⁽⁶⁾		416	544	704	704
LVDS	Transmitter	68	120	160	160
	Receiver	80	136	176	176
PCIe Hard IP Block		1	2	2	2
Hard Memory Controller		2	4	4	4

Related Information

- [High-Speed Differential I/O Interfaces and DPA in Arria V Devices chapter, Arria V Device Handbook](#)

Provides the number of LVDS channels in each device package.

- [Transceiver Architecture in Arria V Devices](#)

Describes 10 Gbps channels usage conditions and SFF-8431 compliance requirements.

Package Plan**Table 7: Package Plan for Arria V GT Devices**

Member Code	F672 (27 mm)			F896 (31 mm)			F1152 (35 mm)			F1517 (40 mm)		
	GPIO	XCVR		GPIO	XCVR		GPIO	XCVR		GPIO	XCVR	
		6-Gbps	10-Gbps		6-Gbps	10-Gbps		6-Gbps	10-Gbps		6-Gbps	10-Gbps
C3	336	3 (9)	4	416	3 (9)	4	—	—	—	—	—	—
C7	—	—	—	384	6 (18)	8	544	6 (24)	12	—	—	—
D3	—	—	—	384	6 (18)	8	544	6 (24)	12	704	6 (24)	12
D7	—	—	—	—	—	—	544	6 (24)	12	704	6 (36)	20

The 6-Gbps transceiver counts are for dedicated 6-Gbps channels. You can also configure any pair of 10-Gbps channels as three 6-Gbps channels—the total number of 6-Gbps channels are shown in brackets. For example, you can also configure the Arria V GT D7 device in the F1517 package with nine 6-Gbps

⁽⁴⁾ The 6 Gbps transceiver counts are for dedicated 6-Gbps channels. You can also configure any pair of 10 Gbps channels as three 6 Gbps channels—the total number of 6 Gbps channels are shown in brackets.

⁽⁵⁾ Chip-to-chip connections only. For 10 Gbps channel usage conditions, refer to the Transceiver Architecture in Arria V Devices chapter.

⁽⁶⁾ The number of GPIOs does not include transceiver I/Os. In the Quartus Prime software, the number of user I/Os includes transceiver I/Os.

Resource		Member Code	
		B3	B5
FPGA PLL		14	14
HPS PLL		3	3
6 Gbps Transceiver		30	30
FPGA GPIO ⁽⁸⁾		540	540
HPS I/O		208	208
LVDS	Transmitter	120	120
	Receiver	136	136
PCIe Hard IP Block		2	2
FPGA Hard Memory Controller		3	3
HPS Hard Memory Controller		1	1
ARM Cortex-A9 MPCore Processor		Dual-core	Dual-core

Related Information

[High-Speed Differential I/O Interfaces and DPA in Arria V Devices chapter, Arria V Device Handbook](#)

Provides the number of LVDS channels in each device package.

Package Plan**Table 11: Package Plan for Arria V SX Devices**

The HPS I/O counts are the number of I/Os in the HPS and does not correlate with the number of HPS-specific I/O pins in the FPGA. Each HPS-specific pin in the FPGA may be mapped to several HPS I/Os.

Member Code	F896 (31 mm)			F1152 (35 mm)			F1517 (40 mm)		
	FPGA GPIO	HPS I/O	XCVR	FPGA GPIO	HPS I/O	XCVR	FPGA GPIO	HPS I/O	XCVR
B3	250	208	12	385	208	18	540	208	30
B5	250	208	12	385	208	18	540	208	30

Arria V ST

This section provides the available options, maximum resource counts, and package plan for the Arria V ST devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Altera Product Selector.

⁽⁸⁾ The number of GPIOs does not include transceiver I/Os. In the Quartus Prime software, the number of user I/Os includes transceiver I/Os.

Resource		Member Code	
		D3	D5
FPGA GPIO ⁽¹⁰⁾		540	540
HPS I/O		208	208
LVDS	Transmitter	120	120
	Receiver	136	136
PCIe Hard IP Block		2	2
FPGA Hard Memory Controller		3	3
HPS Hard Memory Controller		1	1
ARM Cortex-A9 MPCore Processor		Dual-core	Dual-core

Related Information

- [High-Speed Differential I/O Interfaces and DPA in Arria V Devices chapter, Arria V Device Handbook](#)
Provides the number of LVDS channels in each device package.
- [Transceiver Architecture in Arria V Devices](#)
Describes 10 Gbps channels usage conditions and SFF-8431 compliance requirements.

Package Plan**Table 13: Package Plan for Arria V ST Devices**

The HPS I/O counts are the number of I/Os in the HPS and does not correlate with the number of HPS-specific I/O pins in the FPGA. Each HPS-specific pin in the FPGA may be mapped to several HPS I/Os.

Member Code	F896 (31 mm)				F1152 (35 mm)				F1517 (40 mm)			
	FPGA GPIO	HPS I/O	XCVR		FPGA GPIO	HPS I/O	XCVR		FPGA GPIO	HPS I/O	XCVR	
			6 Gbps	10 Gbps			6 Gbps	10 Gbps			6 Gbps	10 Gbps
D3	250	208	12	6	385	208	18	8	540	208	30	16
D5	250	208	12	6	385	208	18	8	540	208	30	16

⁽⁹⁾ Chip-to-chip connections only. For 10 Gbps channel usage conditions, refer to the Transceiver Architecture in Arria V Devices chapter.

⁽¹⁰⁾ The number of GPIOs does not include transceiver I/Os. In the Quartus Prime software, the number of user I/Os includes transceiver I/Os.

I/O Vertical Migration for Arria V Devices

Figure 6: Vertical Migration Capability Across Arria V Device Packages and Densities

The arrows indicate the vertical migration paths. Some packages have several migration paths. The devices included in each vertical migration path are shaded. You can also migrate your design across device densities in the same package option if the devices have the same dedicated pins, configuration pins, and power pins.

Variant	Member Code	Package				
		F672	F780	F896	F 1152	F1517
Arria V GX	A1					
	A3					
	A5					
	A7					
	B1					
	B3					
	B5					
	B7					
Arria V GT	C3					
	C7					
	D3					
	D7					
Arria V GZ	E1					
	E3					
	E5					
	E7					
Arria V SX	B3					
	B5					
Arria V ST	D3					
	D5					

You can achieve the vertical migration shaded in red if you use only up to 320 GPIOs, up to nine 6 Gbps transceiver channels, and up to four 10 Gbps transceiver (for Arria V GT devices). This migration path is not shown in the Quartus Prime software Pin Migration View.

Note: To verify the pin migration compatibility, use the Pin Migration View window in the Quartus Prime software Pin Planner.

Note: Except for Arria V GX A5 and A7, and Arria V GT C7 devices, all other Arria V GX and GT devices require a specific power-up sequence. If you plan to migrate your design from Arria V GX A5 and A7, and Arria V GT C7 devices to other Arria V devices, your design must adhere to the same required power-up sequence.

Table 15: Number of Multipliers in Arria V Devices

The table lists the variable-precision DSP resources by bit precision for each Arria V device.

Variant	Member Code	Variable-precision DSP Block	Independent Input and Output Multiplications Operator				18 x 18 Multiplier Adder Mode	18 x 18 Multiplier Adder Summed with 36 bit Input
			9 x 9 Multiplier	18 x 18 Multiplier	27 x 27 Multiplier	36 x 36 Multiplier		
Arria V GX	A1	240	720	480	240	—	240	240
	A3	396	1,188	792	396	—	396	396
	A5	600	1,800	1,200	600	—	600	600
	A7	800	2,400	1,600	800	—	800	800
	B1	920	2,760	1,840	920	—	920	920
	B3	1,045	3,135	2,090	1,045	—	1,045	1,045
	B5	1,092	3,276	2,184	1,092	—	1,092	1,092
	B7	1,156	3,468	2,312	1,156	—	1,156	1,156
Arria V GT	C3	396	1,188	792	396	—	396	396
	C7	800	2,400	1,600	800	—	800	800
	D3	1,045	3,135	2,090	1,045	—	1,045	1,045
	D7	1,156	3,468	2,312	1,156	—	1,156	1,156
Arria V GZ	E1	800	2,400	1,600	800	400	800	800
	E3	1,044	3,132	2,088	1,044	522	1,044	1,044
	E5	1,092	3,276	2,184	1,092	546	1,092	1,092
	E7	1,139	3,417	2,278	1,139	569	1,139	1,139
Arria V SX	B3	809	2,427	1,618	809	—	809	809
	B5	1,090	3,270	2,180	1,090	—	1,090	1,090
Arria V ST	D3	809	2,427	1,618	809	—	809	809
	D5	1,090	3,270	2,180	1,090	—	1,090	1,090

Embedded Memory Blocks

The embedded memory blocks in the devices are flexible and designed to provide an optimal amount of small- and large-sized memory arrays to fit your design requirements.

Types of Embedded Memory

The Arria V devices contain two types of memory blocks:

- 20 Kb M20K or 10 Kb M10K blocks—blocks of dedicated memory resources. The M20K and M10K blocks are ideal for larger memory arrays while still providing a large number of independent ports.
- 640 bit memory logic array blocks (MLABs)—enhanced memory blocks that are configured from dual-purpose logic array blocks (LABs). The MLABs are ideal for wide and shallow memory arrays. The MLABs are optimized for implementation of shift registers for digital signal processing (DSP) applications, wide shallow FIFO buffers, and filter delay lines. Each MLAB is made up of ten adaptive logic modules (ALMs). In the Arria V devices, you can configure these ALMs as ten 32 x 2 blocks, giving you one 32 x 20 simple dual-port SRAM block per MLAB. You can also configure these ALMs, in Arria V GZ devices, as ten 64 x 1 blocks, giving you one 64 x 10 simple dual-port SRAM block per MLAB.

Embedded Memory Capacity in Arria V Devices

Table 16: Embedded Memory Capacity and Distribution in Arria V Devices

Variant	Member Code	M20K		M10K		MLAB		Total RAM Bit (Kb)
		Block	RAM Bit (Kb)	Block	RAM Bit (Kb)	Block	RAM Bit (Kb)	
Arria V GX	A1	—	—	800	8,000	741	463	8,463
	A3	—	—	1,051	10,510	1538	961	11,471
	A5	—	—	1,180	11,800	1877	1,173	12,973
	A7	—	—	1,366	13,660	2317	1,448	15,108
	B1	—	—	1,510	15,100	2964	1,852	16,952
	B3	—	—	1,726	17,260	3357	2,098	19,358
	B5	—	—	2,054	20,540	4052	2,532	23,072
	B7	—	—	2,414	24,140	4650	2,906	27,046
Arria V GT	C3	—	—	1,051	10,510	1538	961	11,471
	C7	—	—	1,366	13,660	2317	1,448	15,108
	D3	—	—	1,726	17,260	3357	2,098	19,358
	D7	—	—	2,414	24,140	4650	2,906	27,046
Arria V GZ	E1	585	11,700	—	—	4,151	2,594	14,294
	E3	957	19,140	—	—	6,792	4,245	23,385
	E5	1,440	28,800	—	—	7,548	4,718	33,518
	E7	1,700	34,000	—	—	8,490	5,306	39,306
Arria V SX	B3	—	—	1,729	17,290	3223	2,014	19,304
	B5	—	—	2,282	22,820	4253	2,658	25,478

External Memory Performance

Table 18: External Memory Interface Performance in Arria V Devices

Interface	Voltage (V)	Hard Controller (MHz)	Soft Controller (MHz)	
		Arria V GX, GT, SX, and ST	Arria V GX, GT, SX, and ST	Arria V GZ
DDR3 SDRAM	1.5	533	667	800
	1.35	533	600	800
DDR2 SDRAM	1.8	400	400	400
LPDDR2 SDRAM	1.2	—	400	—
RLDRAM 3	1.2	—	—	667
RLDRAM II	1.8	—	400	533
	1.5	—	400	533
QDR II+ SRAM	1.8	—	400	500
	1.5	—	400	500
QDR II SRAM	1.8	—	400	333
	1.5	—	400	333
DDR II+ SRAM ⁽¹²⁾	1.8	—	400	—
	1.5	—	400	—

Related Information

[External Memory Interface Spec Estimator](#)

For the latest information and to estimate the external memory system performance specification, use Altera's External Memory Interface Spec Estimator tool.

HPS External Memory Performance

Table 19: HPS External Memory Interface Performance

The hard processor system (HPS) is available in Arria V SoC devices only.

Interface	Voltage (V)	HPS Hard Controller (MHz)
DDR3 SDRAM	1.5	533
	1.35	533
LPDDR2 SDRAM	1.2	333

⁽¹²⁾ Not available as Altera® IP.

Figure 9: Device Chip Overview for Arria V GX and GT Devices

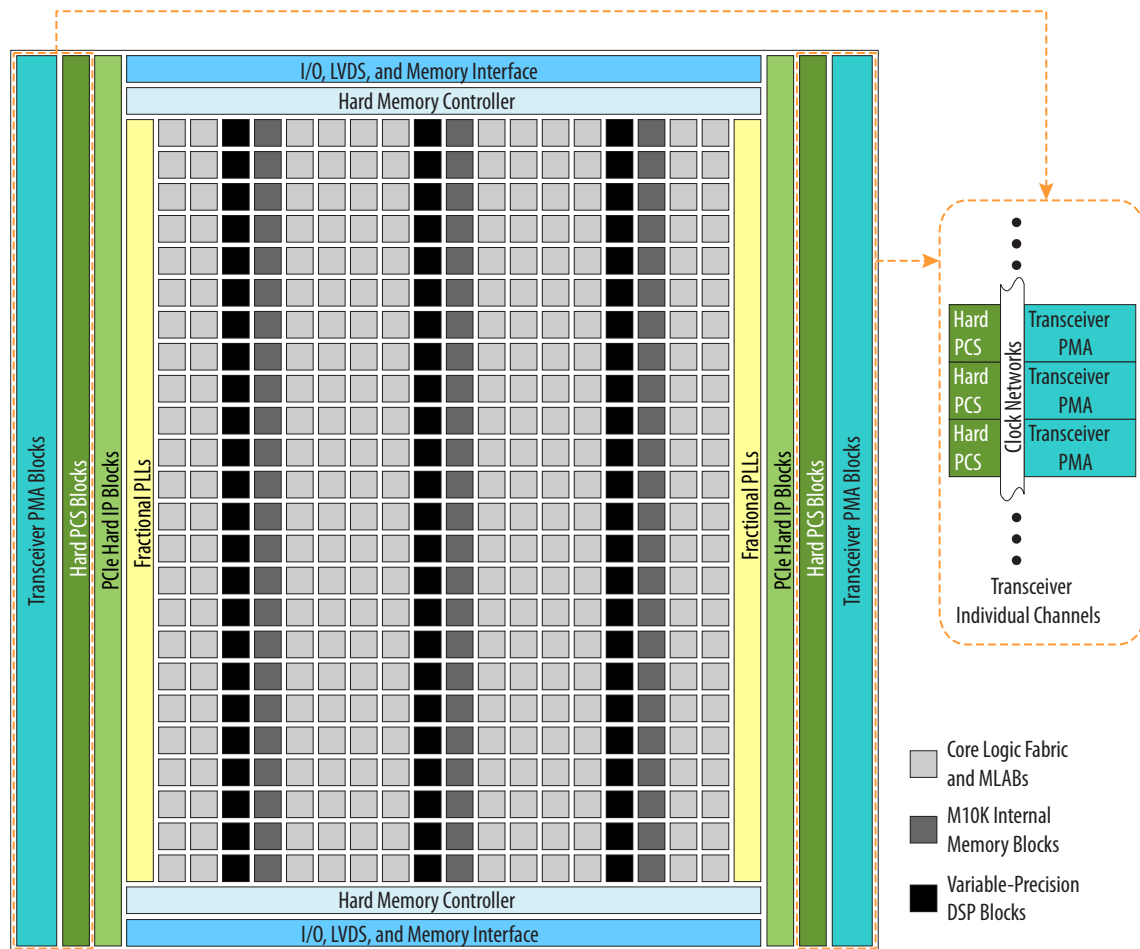
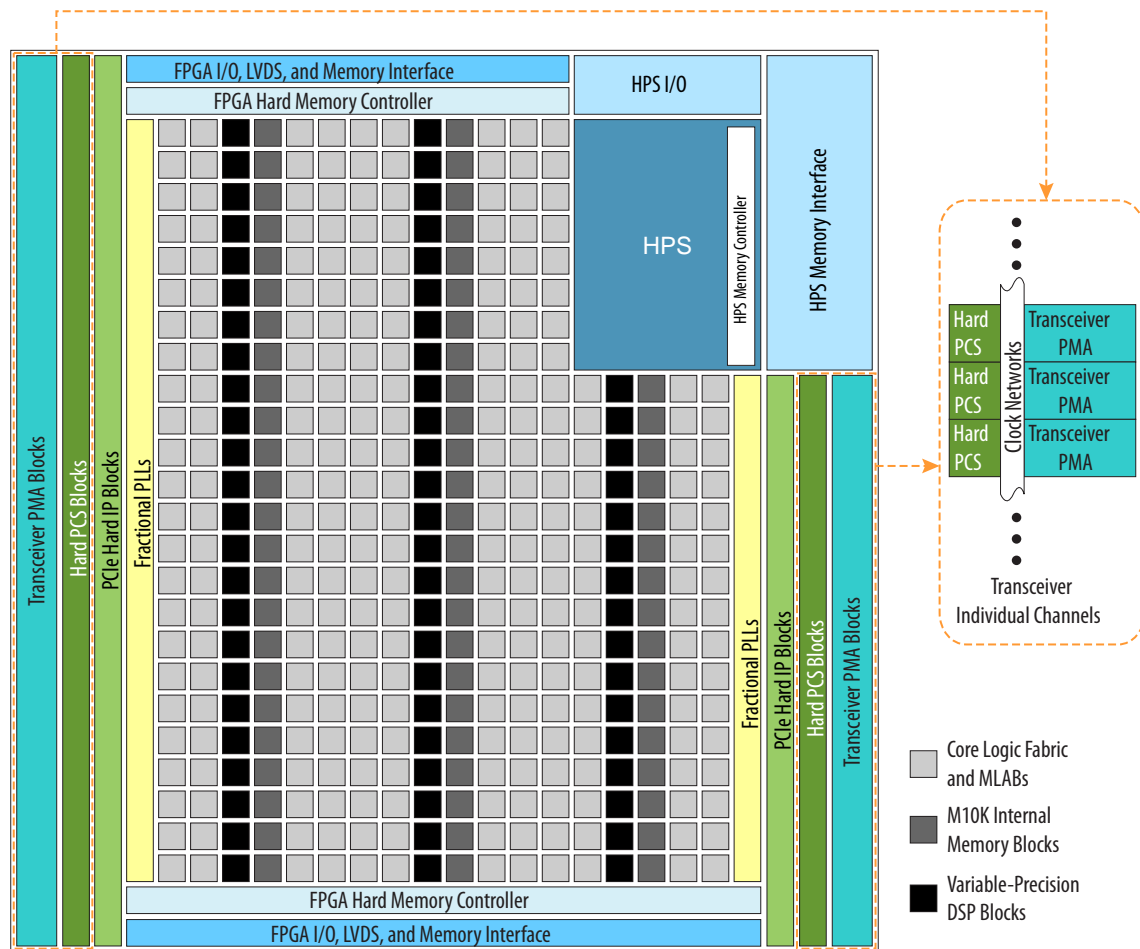


Figure 11: Device Chip Overview for Arria V SX and ST Devices



PMA Features

To prevent core and I/O noise from coupling into the transceivers, the PMA block is isolated from the rest of the chip—ensuring optimal signal integrity. For the transceivers, you can use the channel PLL of an unused receiver PMA as an additional transmit PLL.

Table 20: PMA Features of the Transceivers in Arria V Devices

Features	Capability
Backplane support	<ul style="list-style-type: none"> Arria V GX, GT, SX, and ST devices—Driving capability at 6.5536 Gbps with up to 25 dB channel loss Arria V GZ devices—Driving capability at 12.5 Gbps with up to 16 dB channel loss
Chip-to-chip support	<ul style="list-style-type: none"> Arria V GX, GT, SX, and ST devices—Up to 10.3125 Gbps Arria V GZ devices—Up to 12.5 Gbps

PCS Support ⁽¹³⁾	Data Rates (Gbps)	Transmitter Data Path Feature	Receiver Data Path Feature
PCIe Gen1 (x1, x2, x4, x8)	2.5 and 5.0	<ul style="list-style-type: none"> Phase compensation FIFO Byte serializer 8B/10B encoder PIPE 2.0 interface to the core logic 	<ul style="list-style-type: none"> Word aligner 8B/10B decoder Byte deserializer Phase compensation FIFO Rate match FIFO PIPE 2.0 interface to the core logic
PCIe Gen2 ⁽¹⁴⁾ (x1, x2, x4)			
GbE	1.25	<ul style="list-style-type: none"> Phase compensation FIFO Byte serializer 8B/10B encoder 	<ul style="list-style-type: none"> Word aligner 8B/10B decoder Byte deserializer Phase compensation FIFO Rate match FIFO
XAUI ⁽¹⁵⁾	3.125	<ul style="list-style-type: none"> Phase compensation FIFO Byte serializer 8B/10B encoder XAUI state machine for bonding four channels 	<ul style="list-style-type: none"> Word aligner 8B/10B decoder Byte deserializer Phase compensation FIFO XAUI state machine for realigning four channels Deskew FIFO circuitry
SDI	0.27 ⁽¹⁶⁾ , 1.485, 2.97	<ul style="list-style-type: none"> Phase compensation FIFO Byte serializer 	<ul style="list-style-type: none"> Byte deserializer Phase compensation FIFO
GPON ⁽¹⁷⁾	1.25 and 2.5		
CPRI ⁽¹⁸⁾	0.6144 to 6.144	<ul style="list-style-type: none"> Phase compensation FIFO Byte serializer 8B/10B encoder TX deterministic latency 	<ul style="list-style-type: none"> Word aligner 8B/10B decoder Byte deserializer Phase compensation FIFO RX deterministic latency

⁽¹³⁾ Data rates above 6.5536 Gbps up to 10.3125 Gbps, such as 10GBASE-R, are supported through the soft PCS.

⁽¹⁴⁾ PCIe Gen2 is supported only through the PCIe hard IP.

⁽¹⁵⁾ XAUI is supported through the soft PCS.

⁽¹⁶⁾ The 0.27 Gbps data rate is supported using oversampling user logic that you must implement in the FPGA fabric.

⁽¹⁷⁾ The GPON standard does not support burst mode.

⁽¹⁸⁾ CPRI data rates above 6.5536 Gbps, such as 9.8304 Gbps, are supported through the soft PCS.

Table 22: Transceiver PCS Features for Arria V GZ Devices

Protocol	Data Rates (Gbps)	Transmitter Data Path Features	Receiver Data Path Features
Custom PHY	0.6 to 9.80	<ul style="list-style-type: none"> Phase compensation FIFO Byte serializer 8B/10B encoder Bit-slip Channel bonding 	<ul style="list-style-type: none"> Word aligner Deskew FIFO Rate match FIFO 8B/10B decoder Byte deserializer Byte ordering
GPON	1.25 and 2.5		
Custom 10G PHY	9.98 to 12.5	<ul style="list-style-type: none"> TX FIFO Gear box Bit-slip 	<ul style="list-style-type: none"> RX FIFO Gear box
PCIe Gen1 (x1, x2, x4, x8)	2.5 and 5.0	<ul style="list-style-type: none"> Phase compensation FIFO Byte serializer 8B/10B encoder Bit-slip Channel bonding PIPE 2.0 interface to core logic 	<ul style="list-style-type: none"> Word aligner Deskew FIFO Rate match FIFO 8B/10B decoder Byte deserializer, Byte ordering PIPE 2.0 interface to core logic
PCIe Gen2 (x1, x2, x4, x8)			
PCIe Gen3 (x1, x2, x4, x8)	8.0	<ul style="list-style-type: none"> Phase compensation FIFO 128B/130B encoder Scrambler Gear box Bit-slip 	<ul style="list-style-type: none"> Block synchronization Rate match FIFO 128B/130B decoder Descrambler Phase compensation FIFO
10GbE	10.3125	<ul style="list-style-type: none"> TX FIFO 64B/66B encoder Scrambler Gear box 	<ul style="list-style-type: none"> RX FIFO 64B/66B decoder Descrambler Block synchronization Gear box
Interlaken	3.125 to 12.5	<ul style="list-style-type: none"> TX FIFO Frame generator CRC-32 generator Scrambler Disparity generator Gear box 	<ul style="list-style-type: none"> RX FIFO Frame generator CRC-32 checker Frame decoder Descrambler Disparity checker Block synchronization Gear box

Protocol	Data Rates (Gbps)	Transmitter Data Path Features	Receiver Data Path Features
40GBASE-R Ethernet	4 x 10.3125	<ul style="list-style-type: none"> TX FIFO 64B/66B encoder Scrambler Alignment marker insertion Gearbox Block stripper 	<ul style="list-style-type: none"> RX FIFO 64B/66B decoder Descrambler Lane reorder Deskew Alignment marker lock Block synchronization Gear box Destripper
100GBASE-R Ethernet	10 x 10.3125		
40G and 100G OTN	(4 +1) x 11.3	<ul style="list-style-type: none"> TX FIFO Channel bonding Byte serializer 	<ul style="list-style-type: none"> RX FIFO Lane deskew Byte deserializer
	(10 +1) x 11.3		
GbE	1.25	<ul style="list-style-type: none"> Phase compensation FIFO Byte serializer 8B/10B encoder Bit-slip Channel bonding GbE state machine 	<ul style="list-style-type: none"> Word aligner Deskew FIFO Rate match FIFO 8B/10B decoder Byte deserializer Byte ordering GbE state machine
XAUI	3.125 to 4.25	<ul style="list-style-type: none"> Phase compensation FIFO Byte serializer 8B/10B encoder Bit-slip Channel bonding XAUI state machine for bonding four channels 	<ul style="list-style-type: none"> Word aligner Deskew FIFO Rate match FIFO 8B/10B decoder Byte deserializer Byte ordering XAUI state machine for realigning four channels
SRIO	1.25 to 6.25	<ul style="list-style-type: none"> Phase compensation FIFO Byte serializer 8B/10B encoder Bit-slip Channel bonding SRIO V2.1-compliant x2 and x4 channel bonding 	<ul style="list-style-type: none"> Word aligner Deskew FIFO Rate match FIFO 8B/10B decoder Byte deserializer Byte ordering SRIO V2.1-compliant x2 and x4 deskew state machine

SoC with HPS

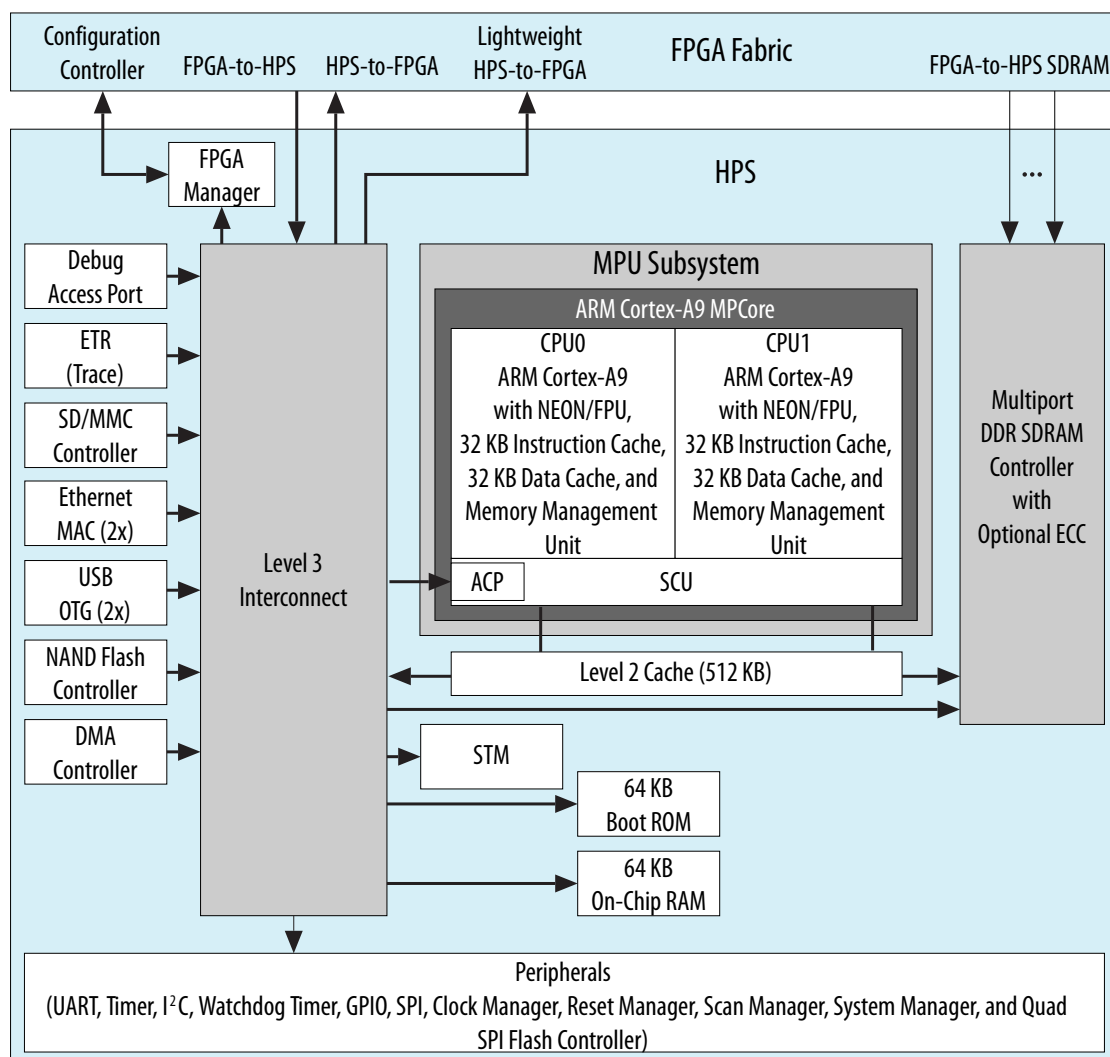
Each SoC combines an FPGA fabric and an HPS in a single device. This combination delivers the flexibility of programmable logic with the power and cost savings of hard IP in these ways:

- Reduces board space, system power, and bill of materials cost by eliminating a discrete embedded processor
- Allows you to differentiate the end product in both hardware and software, and to support virtually any interface standard
- Extends the product life and revenue through in-field hardware and software updates

HPS Features

The HPS consists of a dual-core ARM Cortex-A9 MPCore processor, a rich set of peripherals, and a shared multiport SDRAM memory controller, as shown in the following figure.

Figure 12: HPS with Dual-Core ARM Cortex-A9 MPCore Processor



System Peripherals and Debug Access Port

Each Ethernet MAC, USB OTG, NAND flash controller, and SD/MMC controller module has an integrated DMA controller. For modules without an integrated DMA controller, an additional DMA controller module provides up to eight channels of high-bandwidth data transfers. Peripherals that communicate off-chip are multiplexed with other peripherals at the HPS pin level. This allows you to choose which peripherals to interface with other devices on your PCB.

The debug access port provides interfaces to industry standard JTAG debug probes and supports ARM CoreSight debug and core traces to facilitate software development.

HPS–FPGA AXI Bridges

The HPS–FPGA bridges, which support the Advanced Microcontroller Bus Architecture (AMBA®) Advanced eXtensible Interface (AXI™) specifications, consist of the following bridges:

- FPGA-to-HPS AXI bridge—a high-performance bus supporting 32, 64, and 128 bit data widths that allows the FPGA fabric to issue transactions to slaves in the HPS.
- HPS-to-FPGA AXI bridge—a high-performance bus supporting 32, 64, and 128 bit data widths that allows the HPS to issue transactions to slaves in the FPGA fabric.
- Lightweight HPS-to-FPGA AXI bridge—a lower latency 32 bit width bus that allows the HPS to issue transactions to slaves in the FPGA fabric. This bridge is primarily used for control and status register (CSR) accesses to peripherals in the FPGA fabric.

The HPS–FPGA AXI bridges allow masters in the FPGA fabric to communicate with slaves in the HPS logic, and vice versa. For example, the HPS-to-FPGA AXI bridge allows you to share memories instantiated in the FPGA fabric with one or both microprocessors in the HPS, while the FPGA-to-HPS AXI bridge allows logic in the FPGA fabric to access the memory and peripherals in the HPS.

Each HPS–FPGA bridge also provides asynchronous clock crossing for data transferred between the FPGA fabric and the HPS.

HPS SDRAM Controller Subsystem

The HPS SDRAM controller subsystem contains a multiport SDRAM controller and DDR PHY that are shared between the FPGA fabric (through the FPGA-to-HPS SDRAM interface), the level 2 (L2) cache, and the level 3 (L3) system interconnect. The FPGA-to-HPS SDRAM interface supports AMBA AXI and Avalon® Memory-Mapped (Avalon-MM) interface standards, and provides up to six individual ports for access by masters implemented in the FPGA fabric.

To maximize memory performance, the SDRAM controller subsystem supports command and data reordering, deficit round-robin arbitration with aging, and high-priority bypass features. The SDRAM controller subsystem supports DDR2, DDR3, or LPDDR2 devices up to 4 Gb in density operating at up to 533 MHz (1066 Mbps data rate).

FPGA Configuration and Processor Booting

The FPGA fabric and HPS in the SoC are powered independently. You can reduce the clock frequencies or gate the clocks to reduce dynamic power, or shut down the entire FPGA fabric to reduce total system power.

Mode	Data Width	Max Clock Rate (MHz)	Max Data Rate (Mbps)	Decompression	Design Security	Partial Reconfiguration ⁽²⁰⁾	Remote System Update
FPP	8 bits	125	—	Yes	Yes	—	Parallel flash loader
	16 bits	125	—	Yes	Yes	Yes ⁽²¹⁾	
	32 bits ⁽²²⁾	100	—	Yes	Yes	—	
CvP (PCIe)	x1, x2, x4, and x8 lanes	—	—	Yes	Yes	Yes	—
JTAG	1 bit	33	33	—	—	—	—
Configuration via HPS	16 bits	125	—	Yes	Yes	Yes ⁽²¹⁾	Parallel flash loader
	32 bits	100	—	Yes	Yes	—	

Instead of using an external flash or ROM, you can configure the Arria V devices through PCIe using CvP. The CvP mode offers the fastest configuration rate and flexibility with the easy-to-use PCIe hard IP block interface. The Arria V CvP implementation conforms to the PCIe 100 ms power-up-to-active time requirement.

Note: Although Arria V GZ devices support PCIe Gen3, you can use only PCIe Gen1 and PCIe Gen2 for CvP configuration scheme.

Related Information

[Configuration via Protocol \(CvP\) Implementation in Altera FPGAs User Guide](#)

Provides more information about CvP.

Power Management

Leveraging the FPGA architectural features, process technology advancements, and transceivers that are designed for power efficiency, the Arria V devices consume less power than previous generation Arria V FPGAs:

- Total device core power consumption—less by up to 50%.
- Transceiver channel power consumption—less by up to 50%.

Additionally, Arria V devices contain several hard IP blocks, including PCIe Gen1, Gen2, and Gen3, GbE, SRIO, GPON, and CPRI protocols, that reduce logic resources and deliver substantial power savings of up to 25% less power than equivalent soft implementations.

⁽²⁰⁾ Partial reconfiguration is an advanced feature of the device family. If you are interested in using partial reconfiguration, contact Altera for support.

⁽²¹⁾ Supported at a maximum clock rate of 62.5 MHz.

⁽²²⁾ Arria V GZ only

Document Revision History

Date	Version	Changes
December 2015	2015.12.21	<ul style="list-style-type: none"> Updated RoHS and optional suffix information in sample ordering code and available options diagrams for Arria V GX and GT devices. Changed instances of <i>Quartus II</i> to <i>Quartus Prime</i>.
January 2015	2015.01.23	<ul style="list-style-type: none"> Updated package dimension for Arria V GZ H780 package from 29 mm to 33 mm. Updated dual-core ARM Cortex-A9 MPCore processor maximum frequency from 800 MHz to 1.05 GHz.
December 2013	2013.12.26	<ul style="list-style-type: none"> 10-Gbps Ethernet (10GbE) PCS and Interlaken PCS are for Arria V GZ only. Removed "Preliminary" texts from Ordering Code figures, Maximum Resources, Package Plan and I/O Vertical Migration tables. Added link to Altera Product Selector for each device variant. Added leaded package options. Removed the note "The number of PLLs includes general-purpose fractional PLLs and transceiver fractional PLLs." for all PLLs in the Maximum Resource Counts table. Corrected FPGA GPIO for Arria V SX B3 and B5 as well as Arria V ST D3 and D5 F896 package from 170 to 250. Corrected FPGA GPIO for Arria V SX B3 and B5 as well as Arria V ST D3 and D5 F1152 package from 350 to 385. Corrected FPGA GPIO for Arria V SX B3 and B5 as well as Arria V ST D3 and D5 F1517 package from 528 to 540. Corrected LVDS Transmitter for Arria V SX B3 and B5 as well as Arria V ST D3 and D5 devices from 121 to 120. Added links to Altera's External Memory Spec Estimator tool to the topics listing the external memory interface performance. Added x2 for PCIe Gen3, Gen 2, and Gen 1.
August 2013	2013.08.19	<ul style="list-style-type: none"> Removed the note about the PCIe hard IP on the right side of the device in the F896 package of the Arria V GX variant. These devices do not have PCIe hard IP on the right side. Added transceiver speed grade 6 to the available options of the Arria V SX variant. Corrected the maximum LVDS transmitter channel counts for the Arria V GX A1 and A3 devices from 68 to 67. Corrected the maximum FPGA GPIO count for Arria V ST D5 devices from 540 to 528.

Date	Version	Changes
June 2013	2013.06.03	<ul style="list-style-type: none">Removed statements about contacting Altera for SFF-8431 compliance requirements. Refer to the Transceiver Architecture in Arria V Devices chapter for the requirements.
May 2013	2013.05.06	<ul style="list-style-type: none">Moved all links to the Related Information section of respective topics for easy reference.Added link to the known document issues in the Knowledge Base.Updated the available options, maximum resource counts, and per package information for the Arria V SX and ST device variants.Updated the variable DSP multipliers counts for the Arria V SX and ST device variants.Clarified that partial reconfiguration is an advanced feature. Contact Altera for support of the feature.Added footnote to clarify that MLAB 64 bits depth is available only for Arria V GZ devices.Updated description about power-up sequence requirement for device migration to improve clarity.
January 2013	2013.01.11	<ul style="list-style-type: none">Added the L optional suffix to the Arria V GZ ordering code for the – I3 speed grade.Added a note about the power-up sequence requirement if you plan to migrate your design from the Arria V GX A5 and A7, and Arria V GT C7 devices to other Arria V devices.
November 2012	2012.11.19	<ul style="list-style-type: none">Updated the summary of features.Updated Arria V GZ information regarding 3.3 V I/O support.Removed Arria V GZ engineering sample ordering code.Updated the maximum resource counts for Arria V GX and GZ.Updated Arria V ST ordering codes for transceiver count.Updated transceiver counts for Arria V ST packages.Added simplified floorplan diagrams for Arria V GZ, SX, and ST.Added FPP x32 configuration mode for Arria V GZ only.Updated CvP (PCIe) remote system update support information.Added HPS external memory performance information.Updated template.
October 2012	3.0	<ul style="list-style-type: none">Added Arria V GZ information.Updated Table 1, Table 2, Table 3, Table 14, Table 15, Table 16, Table 17, Table 18, Table 19, Table 20, and Table 21.Added the “Arria V GZ” section.Added Table 8, Table 9 and Table 22.